

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6991	438/149.ccls. or 257/347.ccls. or 257/E27.001. ccls. or 257/ E21.085.ccls. or 257/E21.533. ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:32
L2	5010915	separate or separating or separation or cleave or cleaving or brittle	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:33
L3	2660859	wire or wiring	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:34
L4	9101447	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:34
L5	877150	etch\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:34
L6	2518	L2 SAME L3 SAME L4 SAME L5	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:34
L7	2797988	(thin film transistor) or "TFT" or "IDF" or chip or "IC" or (integrated circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:35

L8	433670	L7 SAME substrate	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:35
L9	21	L6 AND L1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:35
L10	861	L6 AND L8	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:35
L11	11250097	connect\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:36
L12	196768	L11 SAME L7 SAME L3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:37
L13	76	"L19" AND L12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:37
L14	76	L13 NOT L9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:37
L15	12	L14 AND ("438". CLAS. OR "257". CLAS.)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:42

L17	1	(separation and wiring and connection and etchant).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:54
L18	6	(separation and wiring and etchant).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/06/15 13:54

**6/15/2009 1:57:24 PM****C:\Documents and Settings\mfan\My Documents\ EAST\ Workspaces\ 10587744.wsp**